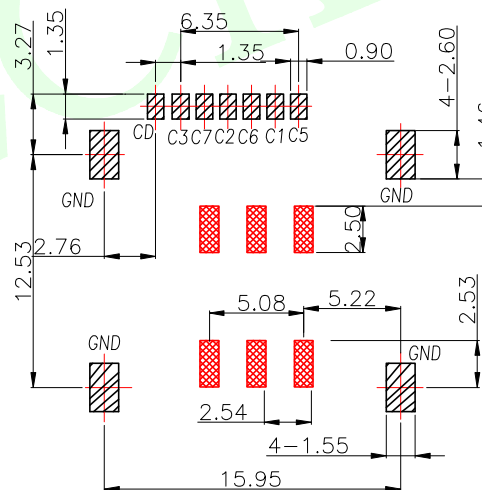
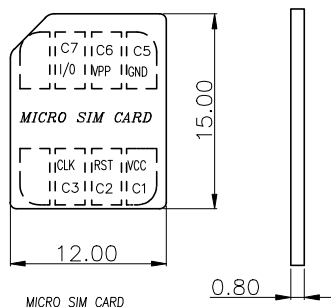
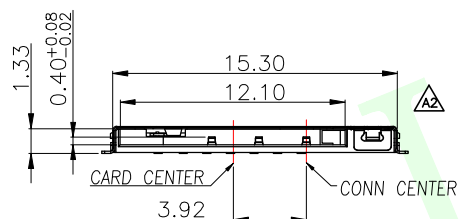
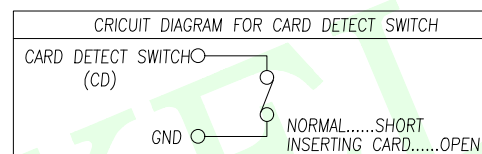
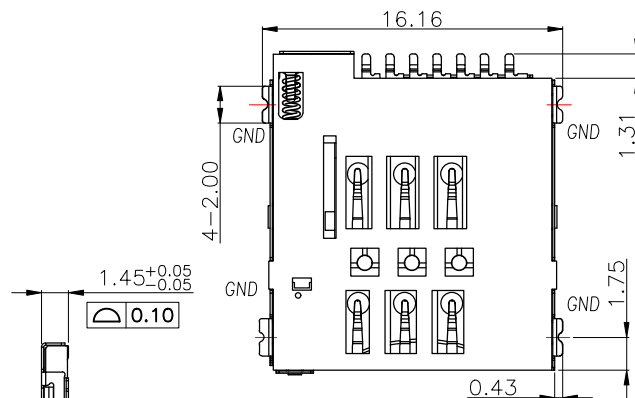
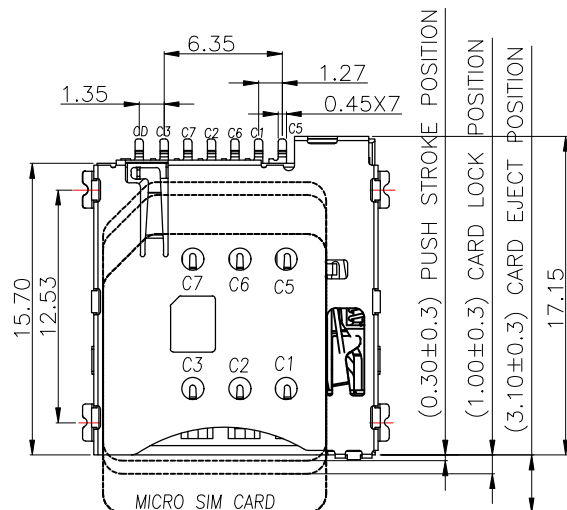


RoHS Compliant



 CIRCUIT TRACE KEEP OUT AREA
 SMT SOLDER AREA
 THERE SHOULD NOT BE ANY CIRCUITRIES
 IN THE LAYOUT SPACE OF THE PRODUCTS.
RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ± 0.05

- 1) MATERIAL:
1.1 HOUSING:LCP,UL94-V0,COLOR:BLACK
1.2 OCONTACT:C5210R-H
1.3 SHELL:SUS304-H
- 2) FINISH:
2.1 TERMINAL:30 u" Min.NICKEL PLATED OVERALL
2.2 CONTACT:GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATED ON SOLDER TAILS;
- 3) ELECTRICAL CHARACTERISTICS
RATING CURRENT : 0.5A MAX.
CONTACT RESISTANCE :30 mΩ MAX
DIELECTRIC WITHSTANDING : 500V AC MIN.
INSULATION RESISTANCE: 1000 MΩ MIN.
- 4) MECHANICAL CHARACTERISTICS
MATING CYCLE :3000 CYCLES
Contact retention force: 50gf/pin Min.

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

LCK-SIM-006 P7 H145-W L G

- LCK**: 连晟欣
- SIM**: 产品类别
 - MS: MINI SIM
 - SIM: MICRO SIM
 - NANO: NANO SIM
- 006**: 产品流水料号识别码
- P7**: 产品PIN位
 - P7: 7PIN
- H145**: 产品高度
 - H145: 1.45MM
- W**: 有柱无柱
 - Y: 有柱
 - W: 无柱
- L**: 包装方式
 - L: 圆盘
- G**: 电镀规格
 - G: gold flash
 - G1: 1U
 - G3: 3U
 - (以此类推)

MEASURE POINT:	
QUADRANT POINT	☐ QP
TANGENCY POINT	☐ TP
INTERSECTION POINT	☐ IP

UNLESS OTHERWISE SPECIFIED, TOLERANCE:	
X.	±0.25
X.x	±0.20
X.xx	±0.15
ANGULAR	±3°

 联晟欣连接器（深圳）有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24	TITLE: MICRO SIM CARD PUSH PUSH 7PIN 1.45H带CD PIN (防呆型)		
CHECKED		DATE				
APPROVED		DATE				
PART NO: LCK-SIM-006P7H145-WLG				REV: 04	SCALE: 1:1	UNIT: mm
DRAWING NO: 1020221026				SIZE: A4	SHEET: 1/1	